



2812

503.39864X00

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant(s): T. SATOH, et al

Serial No.: 09/809,181

Filed: March 16, 2001

For: SEMICONDUCTOR DEVICE AND MANUFACTURING METHOD
THEREOF

Group: 2812

Examiner:

PRELIMINARY AMENDMENT

Commissioner for Patents
Washington, D.C. 20231

October

RECEIVED
NOV 29 2001
TIC 2800 MAIL ROOM

Sir:

The following preliminary amendments and remarks are
respectfully submitted in connection with the above-identified
application.

IN THE SUBSTITUTE SPECIFICATION:

Please replace the Substitute Specification filed on
August 20, 2001 with the attached new Replacement Substitute
Specification.

IN THE CLAIMS:

Please amend the claim 10 as follows:

10. (amended) A semiconductor device according to any of

Claims 4 to [9] 7, wherein an end area of said stress

B1
PMB
C2

RECEIVED
NOV 1 2001
TIC 2800 MAIL ROOM